2<u>56593</u>"供应商

Silicon NPN triple diffusion mesa type

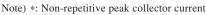
Horizontal deflection output for TV, CRT monitor

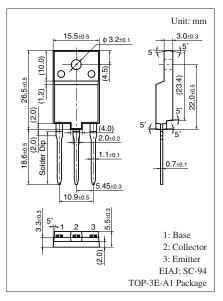
Features

- High breakdown voltage: $V_{CBO} \ge 1700 \text{ V}$
- High speed switching: $t_f < 200$ ns
- Wide safe operation area

Absolute Maximum Ratings $T_C = 25^{\circ}C$

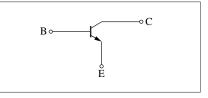
Parameter	Symbol	Rating	Unit	
Collector-base voltage (Emitter open)	V _{CBO}	1 700	V	
Collector-emitter voltage (E-B short)	V _{CES}	1 700	V	
Collector-emitter voltage (Base open)	V _{CEO}	600	V	
Emitter-base voltage (Collector open)	V _{EBO}	7	V	
Base current	IB	7.5	А	
Collector current	I _C	15	А	
Peak collector current *	I _{CP}	25	А	
Collector power dissipation	P _C	60	W	
$T_a = 25^{\circ}C$		3		
Junction temperature	Tj	150	°C	
Storage temperature	T _{stg}	-55 to +150	°C	





Marking Symbol: C5931

Internal Connection

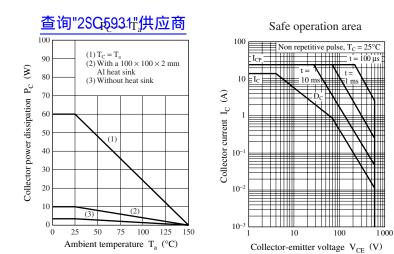


Electrical Characteristics $T_C = 25^{\circ}C \pm 3^{\circ}C$

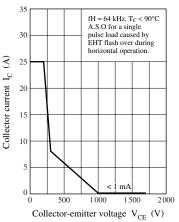
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Collector-base cutoff current (Emitter open)	I _{CBO}	$V_{CB} = 1000 \text{ V}, I_E = 0$			50	μΑ
		$V_{CB} = 1700 \text{ V}, I_E = 0$			1	mA
Emitter-base cutoff current (Collector open)	I _{EBO}	$V_{EB} = 7 V, I_C = 0$			50	μA
Forward current transfer ratio	h _{FE}	$V_{CE} = 5 V, I_C = 7.5 A$	5		10	—
Collector-emitter saturation voltage	V _{CE(sat)}	$I_{C} = 7.5 \text{ A}, I_{B} = 1.88 \text{ A}$			3	V
Base-emitter saturation voltage	V _{BE(sat)}	$I_{C} = 7.5 \text{ A}, I_{B} = 1.88 \text{ A}$			1.5	V
Transition frequency	f _T	$V_{CE} = 10 \text{ V}, I_C = 0.1 \text{ A}, f = 0.5 \text{ MHz}$		3		MHz
Storage time	t _{stg}	$I_C = 7.5 \text{ A}$, Resistance loaded			2.7	μs
Fall time	t _f	$I_{B1} = 1.88 \text{ A}, I_{B2} = -3.75 \text{ A}$			0.2	μs

Note) Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7030 measuring methods for transistors.

Panasonic



Safe operation area (Horizontal operation)



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